



Product Change Notification

109277 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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Product Change Notification

Change Notification #: 109277 - 00
Change Title: Intel® 6402 Advanced Memory Buffer, PCN 109277-00, Product Material, Halogen to Halogen Free
Date of Publication: March 19, 2009

Key Characteristics of the Change:

Product Material

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	May 01, 2009
Date of First Availability of Post-Conversion Material:	May 01, 2009

The date of "First Availability of Post-Conversion Material" is the projected date that a customer may expect to receive the Post-Conversion Materials. This date is determined by the projected depletion of inventory at the time of the PCN publication. The depletion of inventory may be impacted by fluctuating supply and demand, therefore, although customers should be prepared to receive the Post-Converted Materials on this date, Intel will continue to ship and customers may continue to receive the pre-converted materials until the inventory has been depleted.

Description of Change to the Customer:

The Intel® 6402 Advanced Memory Buffer is converting from Halogen to Halogen Free substrate. New S-Spec and MM numbers are provided below for the Intel ® 6402 Advanced Memory Buffer production units.

Customer Impact of Change and Recommended Action:

Intel anticipates no impact to customers.

Products Affected / Intel Ordering Codes:

Marketing Name	Pre Conversion Product Code	Pre Conversion S-Spec	Pre Conversion MM#	Post Conversion Product Code	Post Conversion S-Spec	Post Conversion MM#
QG6402	QG6402	S L9XC	886483	QG6402	SLGQJ	901817

Reference Documents / Attachments:

Document: Materials Data Declaration Sheet **Location #:** <http://intelmdds.pcnalert.com/MDDS/MDDSVIEW.aspx>

PCN Revision History:

Date of Revision: March 19, 2009	Revision Number: 00	Reason: Originally Published PCN
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